06-19-1998	NFORM COVER SHEET Patents Only
To the Honorable Comm $100742481$	MAY 2 9 1998 May 26, 1998 Attorney Dkt: 5649-379
Please record the attached original documents or copy thereo	f.
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):
In-seop Kim Seung-uhn Kim Nam-hee You Soon-young Lee	Samsung Electronics Co., Ltd. 416 Maetan-dong, Paldal-gu Suwon-City, Kyungki-do Republic of Korea
Additional name(s) of conveying party(ies) attached? Yes X No	
3. Nature of conveyance:	
X Assignment Merger Security Agreement Change of Name Other	
Execution Date: April 22, 1998	Additional name(s) & address(es) attached? <u>Yes X</u> No
<ul> <li>4. Application Serial No09/027,302, filed February 20, 1998 Patent No</li> <li>If this document is being filed together with a new application, the execution date of the application is:</li> <li>Additional numbers attached?Yes _X No</li> </ul>	
5. Name and address of party to whom correspondence	6. Total number of applications and patents involved: <u>1</u>
concerning document should be mailed:	7. Total fee (37 CFR 3.41) \$ 40.00 E
Sorojini J. Biswas Myers Bigel Sibley & Sajovec P.O. Box 37428 Raleigh, North Carolina 27627	X Enclosed Authorized to be charged to deposit account
	8. Deposit account number: 50-0220
DO NOT USE THIS SPACE	(Attach duplicate copy of this page if paying by deposit account)
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06/17/1998 SSNITH 00000023 09027302	
01 FC:581 40.00 @P	23
9. Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	
Sorojini J. Biswas. #39,111 Signature Total number of pages including cover sheet, attachments and document: _3	

## ASSIGNMENT

THIS ASSIGNMENT, made by us, **In-seop Kim**, a citizen of the Republic of Korea, residing at San 56-1, Shillim-dong, Kwanak-gu, Seoul, Republic of Korea; **Seung-uhn Kim**, a citizen of the Republic of Korea, residing at 40-3, 5th St., Tosung-dong, Seo-gu, Pusan, Republic of Korea; **Nam-hee You**, a citizen of the Republic of Korea, residing at San24, Nongseo-ri, Kiheung-eub, Yongin-city, Kyungki-do, Republic of Korea and **Soon-young Lee**, a citizen of the Republic of Korea, residing at San24, Nongseo-ri, Kiheung-eub, Yongin-city, Kyungki-do, Republic of Korea.

WITNESSETH: That,

WHEREAS, we are the joint inventors of certain new and useful improvements in NOVEL MICROOGRANISM RESISTANT TO HYDROGEN PEROXIDE for which an application for United States Letters Patent has been filed in the United States Patent and Trademark Office. We hereby authorize and request Myers, Bigel, Sibley & Sajovec, P.A., to insert here in parentheses (Application No. 09/027,302, filed February 20, 1998) the filing date and application number of said application when known, and

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416 Maetan-dong, Paldal-gu, Suwon-City, Kyungki-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer and convey unto the said assignee, its successors and assigns, the entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

We hereby request that said Letters Patent be issued in accordance with this assignment.

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We further covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and application above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to bind our heirs, legal representatives and assigns, promptly to communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns and other legal representatives.

IN WITNESS WHEREOF, we have hereunto set our hands and seals on this  $22 \text{ h} \text{d}_{ay}$  of 4 pvl, 1998.

In-seop Kim

<u>Seung-thin Kim</u>

Naun Hee Mucu Nam-hee You

Soon-young Lee

Witnessed by:

foring in Jung Date: 4/12/1486677 W Date: 4/2/10038